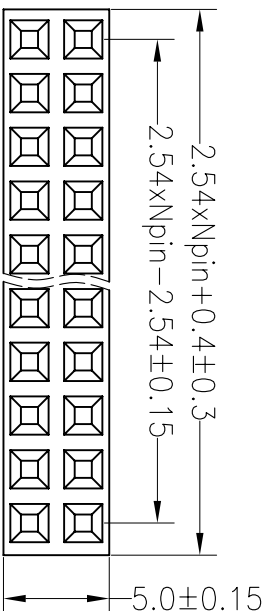
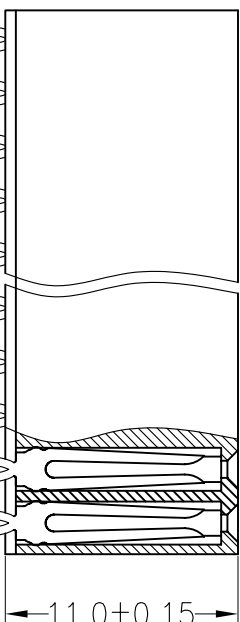
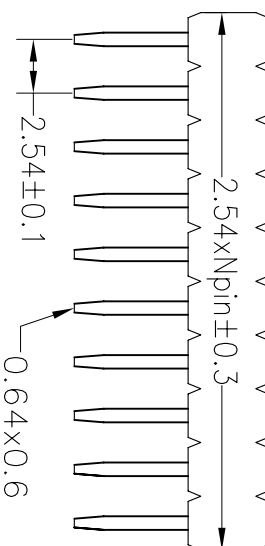


1	2	3	4	5	6	7	8	9
SPECIFICATIONS			Recommended P.C.B Layout(Top Side) (PCB BOARD TOLERANCE±0.05)					
Rated Current:3.0AMP								
Contact Resistance:20mΩ Max								
Withstand Voltage:1000V AC/DC								
Insulation Resistance:1000MΩ Min								
Operation Temperature:-40°c to +105°c								
Contact Material:Brass								
Contact Plating:Au or Sn Over Ni								
Insulator Material:Polyester(UL94V-0)								
Standard: PA6T								
Max.Processing Temp: 230°C for 30-60 seconds (260°C for 10 seconds)								
Ordering Information								
2211X-2 XX XX X S YN 01								
No.of Pins Per Row 2*40 2-80								
Contact Plating G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin								
Insulator Material Option A=BK-PBT B=BK-PA66 C=BK-PA6T D=BK-PA46 F=BK-LCP								
OPERATION			DRAW		SCALE		FIT	
X.X ±0.30			Y.YuSheng 12.03.28		UNIT mm		A4	
X.XX ±0.20			CHECK		SIZE		SHEET 1/1	
X.XXX ±0.10			APPROVE		PROJ.		TITLE:	
ANGLE ±3°							PART NO. 2211X-2XXXXXXSYN01	
DIM TOL							2.54PF H11.0mm 2xNpin 180° PC104	
CHANGE								
DATE			MODIFICATION DESCRIPTION					
REV								
A0			2012.03.28		NEW DRAWING			
A								